

规格 SPECIFICATIONS:

1. 电气特性 ELECTRICAL CHARACTERISTICS:

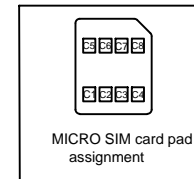
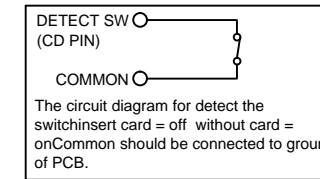
- 1-1. 额定电流 CURRENT RATING: 1A
- 1-2. 接触电阻 CONTACT RESISTANCE:  
1-2-1. 100mΩ MAX. (INITIAL) (FOR C1/C2/C3/C4/C5/C6/C7/C8)  
1-2-2. 500mΩ MAX. (INITIAL) (FOR CD/COMMON)
- 1-3. 绝缘耐压 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
- 1-4. 绝缘电阻 INSULATION RESISTANCE: 100MΩ MIN. BY 500V DC.

2. 机械特性 MECHANICAL CHARACTERISTICS:

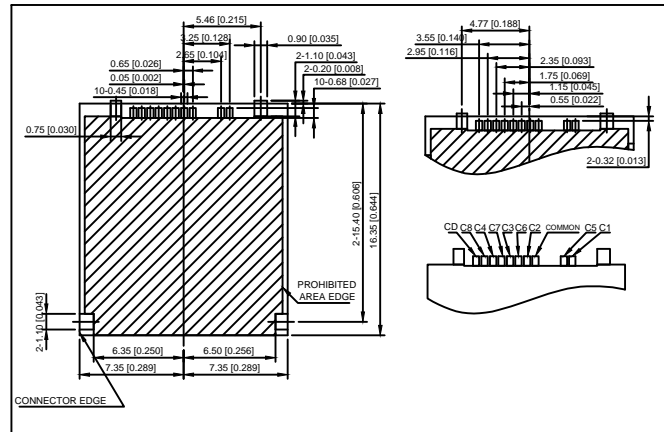
- 2-1. 寿命测试 LIFE TEST: 5000 CYCLES MIN.

3. 环境特性 ENVIRONMENTAL CHARACTERISTICS:

- 3-1. 盐雾试验 SALT MIST TEST CONDITION: PER IEC 68-2-52, SEVERITY(3)
- 3-2. 工作温度 OPERATING TEMPERATURE: -30°~+80°
- 3-3. TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- 3-4. RoHS COMPLIANT PRODUCT.
- 3-5. HALOGEN FREE PRODUCT IDENTIFICATION MARK:
- 3-6. HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:



PIN NO.	PIN ASSIGNMENT
C1	SUPPLY VOLTAGE(VCC)
C2	RESET(RST)
C3	CLOCK(CLK)
C4	RESERVED FOR FUTURE USE(RFU)
C5	GROUND(GND)
C6	PROGRAMMING VOLTAGE(VPP)
C7	I/O
C8	RESERVED FOR FUTURE USE(RFU)



F	LINK	1	STAINLESS STEEL T=0.10	N/A
E	SPRING	1	SWP	NICKEL PLATING
D	SLIDE	1	HIGH TEMP.THERMOPLASTIC,UL94V-0 AND STAINLESS STEEL	BLACK
C	SHELL	1	SUS 301 1/2H T=0.1	NICKEL PLATING
B	CONTACT	1	C5210 EH T=0.10 4SM2019-002002	3U" GOLD PLATING ONCONTACT AREA AND SOLDER AREA,50U' MIN NICKEL UNDER PLATING
A	HOUSING	1	LCP+35%GF S475 UL94V-0	BLACK

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES	DSND	DATE	SCALE: N/A	MODEL TYPE: SIM CARD CONN		
ΔX					ANGLAR ±5°	DWN	DATE	VIEW:	PART NO.:		
ΔX					L ≤ 4 ±0.2	CHKD	DATE	UNIT: mm/in	DWG NO.:		
ΔX					4 < L ≤ 16 ±0.3	APPD	DATE	SIZE: A4	XXSIM-1161		
ΔX					16 < L ≤ 63 ±0.4						
MARK					L > 63 ±0.5						
REVISIONS						XKB INDUSTRIAL PRECISION CO., LIMITED			WEIGHT	SHEET	REVISION
www.xk-dg.cn www.helloxkb.com www.helloxkb.cn									1.0g	1/1	A0